

# Simulation of Monolithic Active Pixel Sensors for ILC ECAL

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# Outline

- **MAPS (Monolithic Active Pixel Sensors) ECAL**
  - Concepts
  - Design
- **Geometry modification in GEANT4 simulation**
- **Demonstration of single  $e^-/\mu^-$  events using full detector simulation**
- **Sensor simulation**
- **Summary of status**
- **Future prospects**

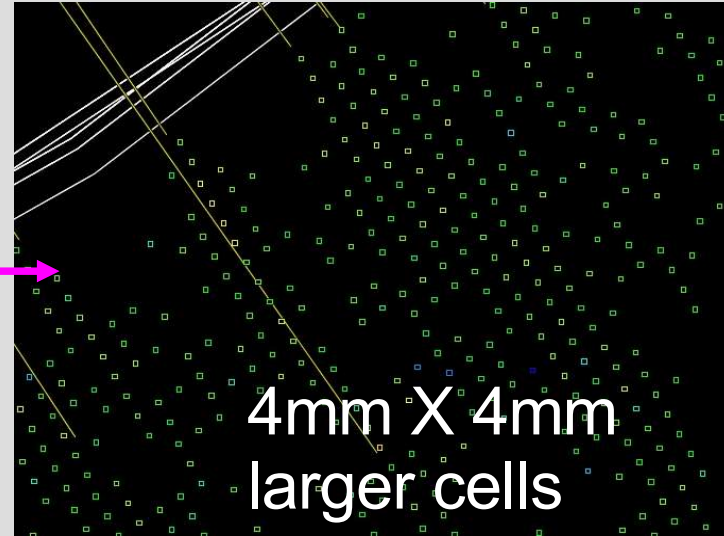
# MAPS ECAL concept

- **High granularity**

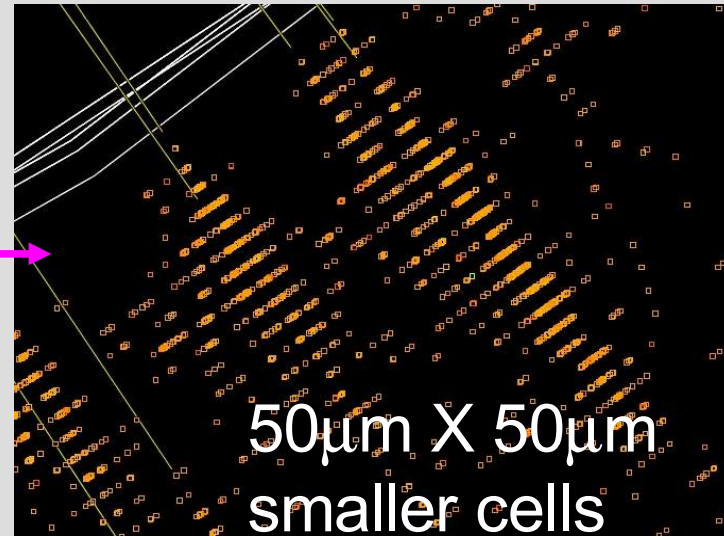
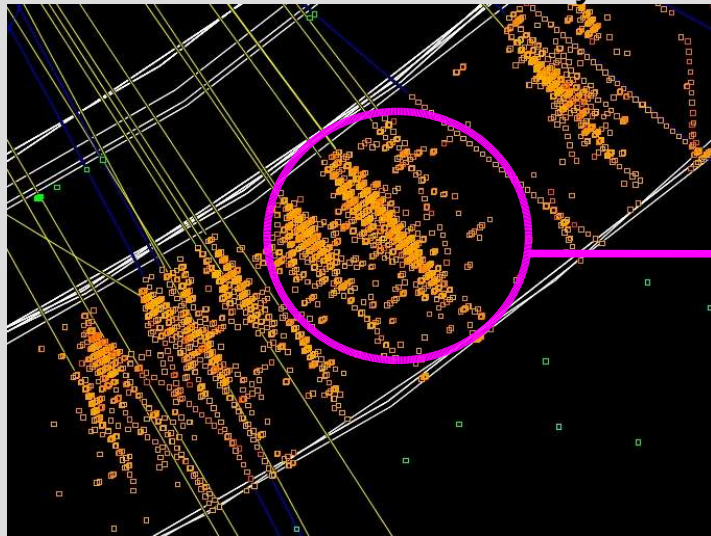
- Small cells
- Digital calorimetry
- Detecting individual particles after electromagnetic shower
- Result in measuring a single particle in each cell
- Binary readout
  - Higher spatial resolution
  - Better performance for particle separation inside jets

- **Cost saving**

- CMOS (Complementary Metal Oxide Semiconductor) silicon
  - Cheaper than higher resistive pure silicon



Preliminary simulation with SLIC



# MAPS Introduction

## Analogue design in Mokka simulation

- 1cm X 1cm cell
- 500 $\mu$ m Si sensitive thickness
- Analogue readout

## MAPS design

- 50 $\mu$ m X 50 $\mu$ m cell
- 15 $\mu$ m Si sensitive thickness
- Binary readout

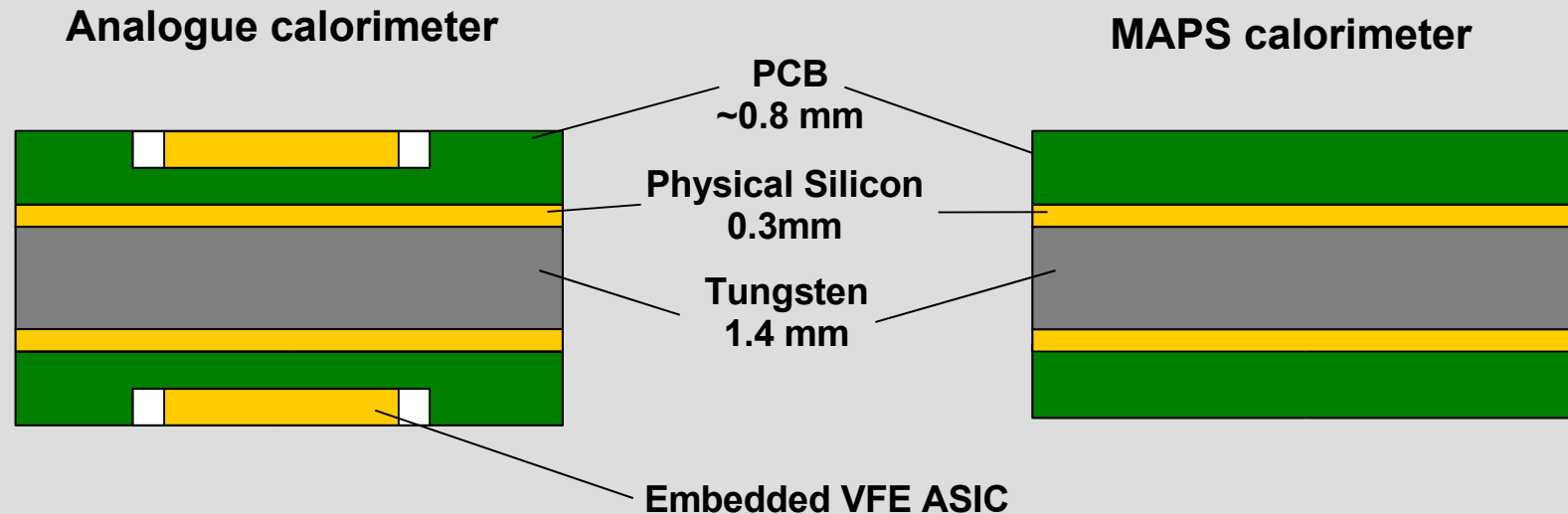
### Si-W sandwich:

Si physical thickness and W thickness are the same for both default design and MAPS design in LDC01.

Si physical thickness: 500 $\mu$ m

W thickness: 2.1mm for first 20 layers  
4.2mm for last 10 layers

# Physical detector slabs

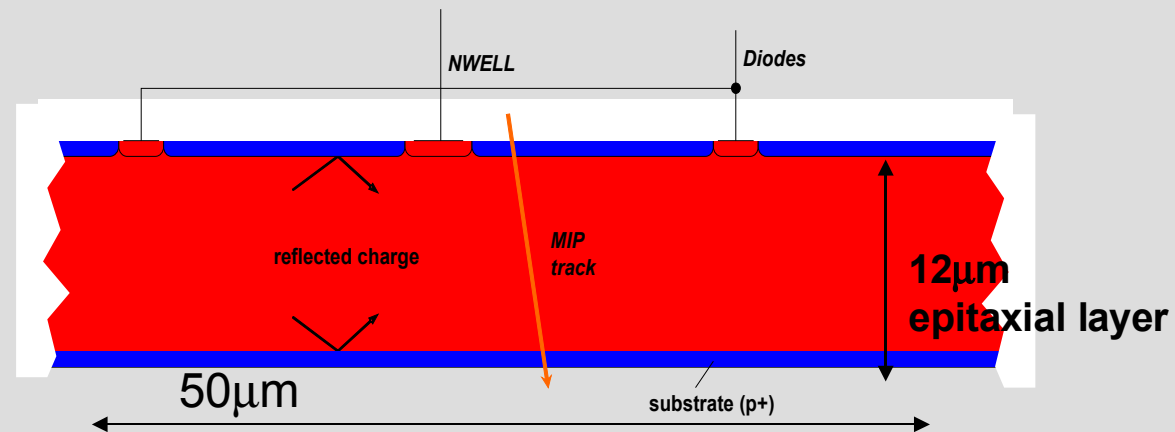


Mechanical structure is the same both for analogue and MAPS designs.

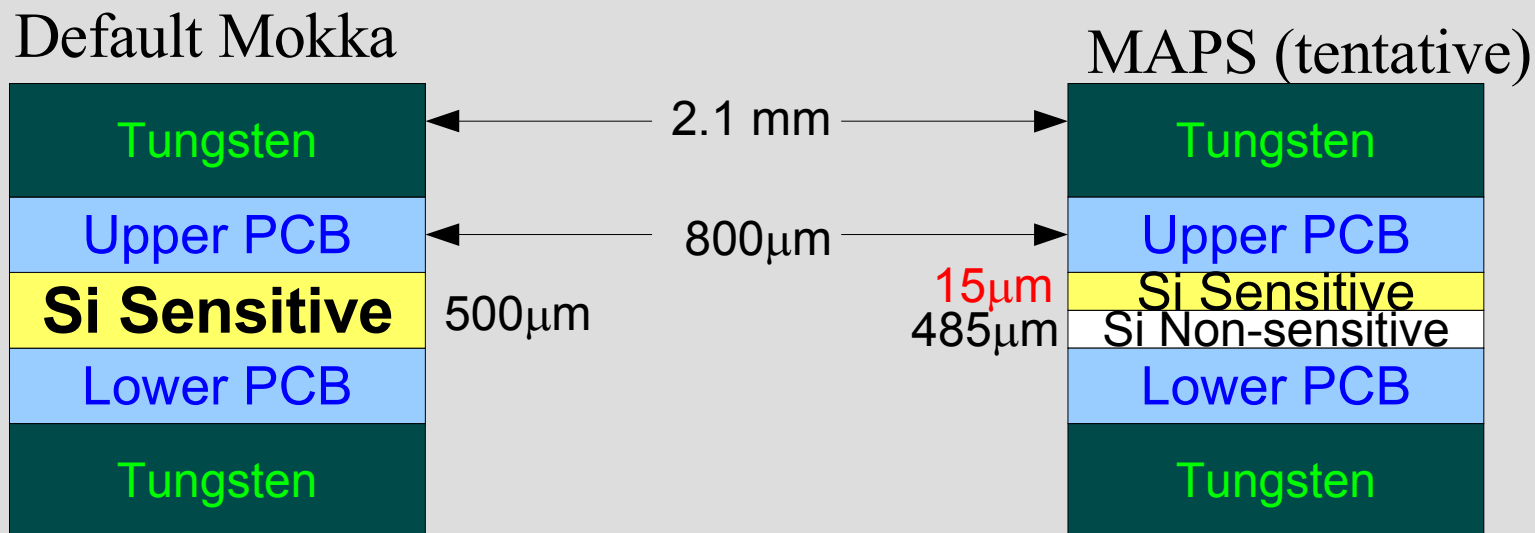
**Charge collected mainly by diffusion:**

(This is not yet modelled for the result of Geant4 simulation which I will show in later slides.)

- Optimization of the diode location and size is necessary.



# Geometry modification in Geant4 full detector simulation



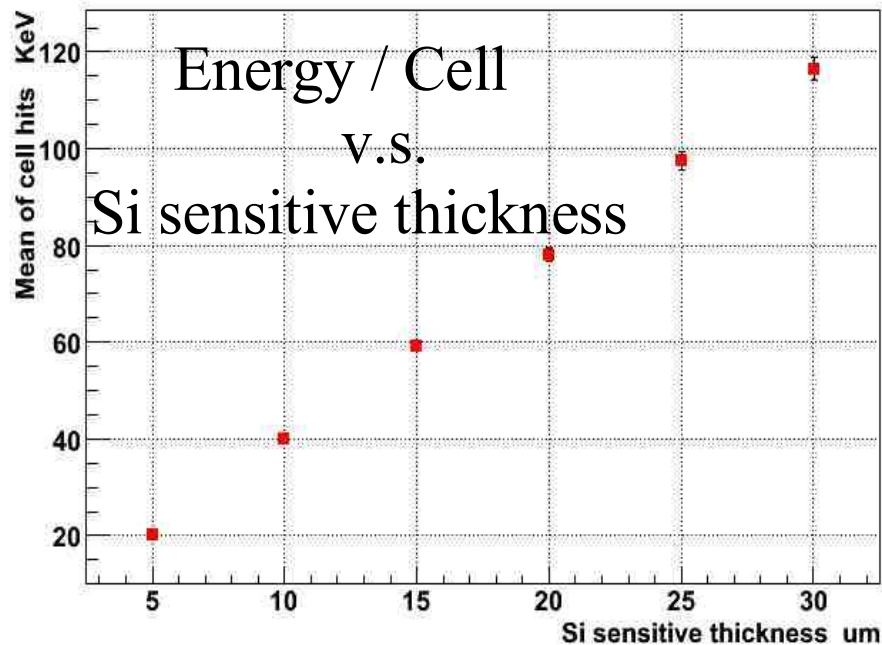
- Mokka 06-00, LDC01
- Ecal02.cc (ECAL Geant4 driver) is modified.
- ➔ Consistency checks:
  - Geant4 Adaptive GUI output is fine.
  - Energy deposit ratio agrees with expectation. (i.e.  $15\mu\text{m}/500\mu\text{m} = 3.0\%$ )
  - Layer position shift agrees with expectation.
  - Linearity for sensitive thickness dependence is represented. (Please see next slide)

# Single $e^-$ simulation (1)

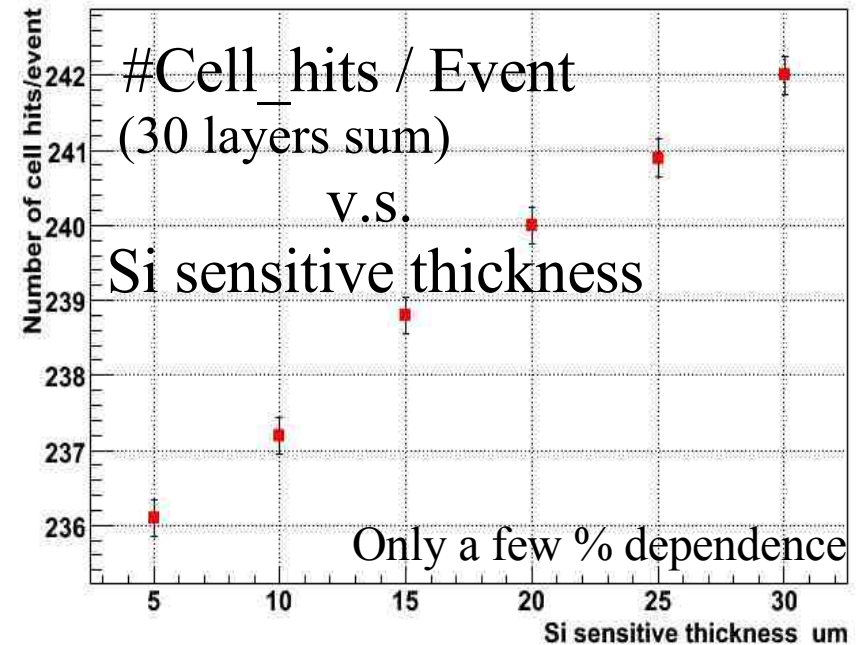
## (Si sensitive thickness dependence)

- 20 GeV single electron (from IP to zenith with 4T magnet on)
- Cell size is 1cm X 1cm
- No threshold is applied for energy of cell hits.

Mean of cell hits with Si sensitive thickness dependence



Number of cell hits with Si sensitive thickness dependence



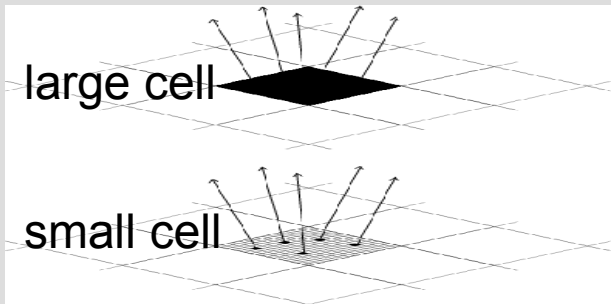
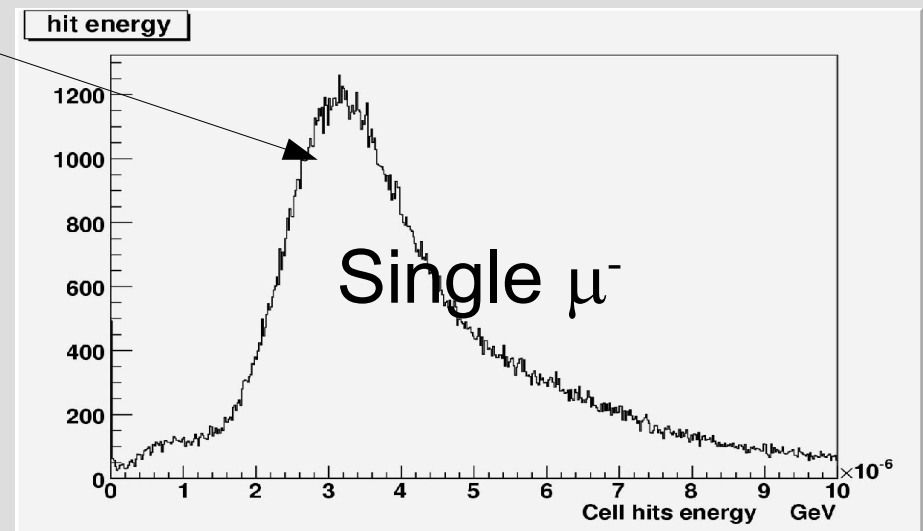
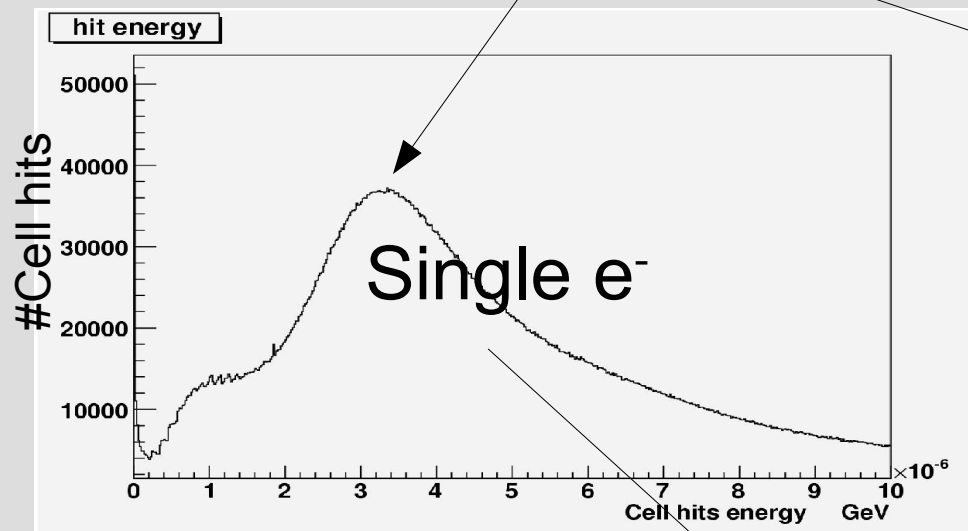


# Single $e^-/\mu^-$ simulation (2)

## (Energy deposit of cell hits)

- 20 GeV single  $e^-/\mu^-$
- 15 $\mu\text{m}$  Si sensitive thickness
- **50 $\mu\text{m}$  X 50 $\mu\text{m}$  cell size**
- **No threshold and no noise is applied.**
- Before sensor level response is implemented.

### Minimum Ionization Particles



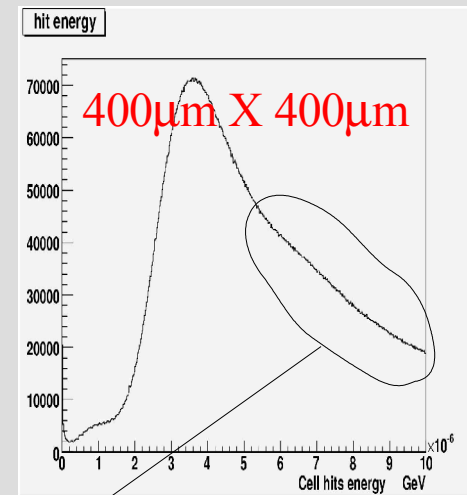
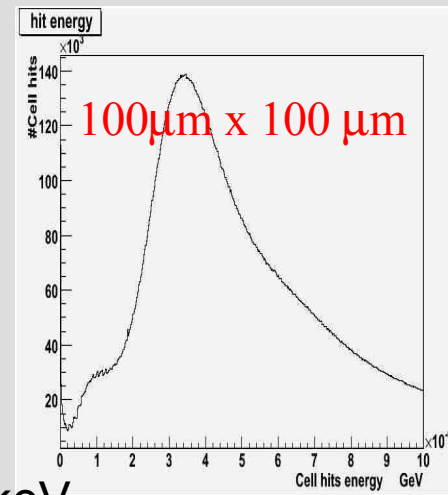
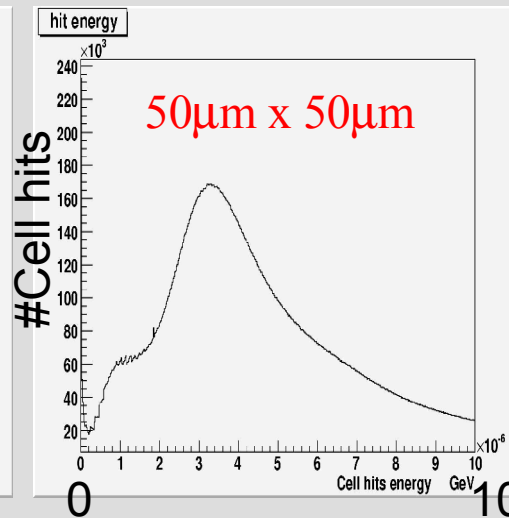
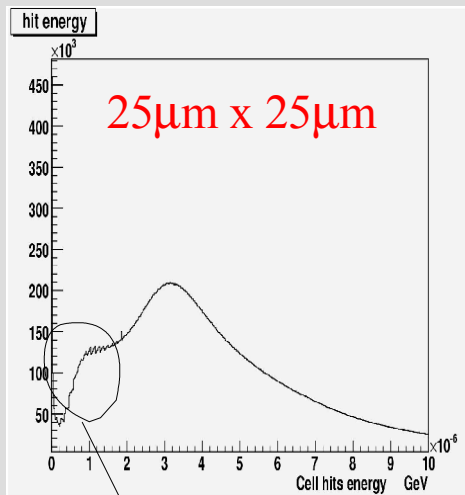
**Individual secondary particles are detected after electromagnetic shower cascade !!**

# Single $e^-$ simulation (3)

## (Cell size dependence)

- 100GeV single  $e^-$
- 15 $\mu\text{m}$  Si sensitive thickness
- No threshold and no noise is applied.
- Before sensor level response is implemented.

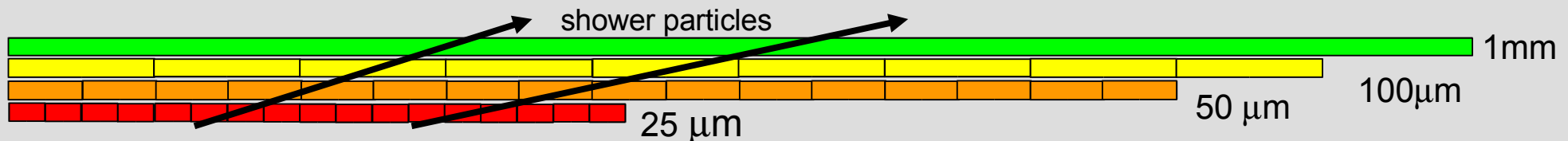
Cell hit energy distributions:



**Charge sharing effects at cell boundary**

**Multi MIPs increase Landau tail**

**50 $\mu\text{m}$  x 50 $\mu\text{m}$  cell size is good working assumption.**

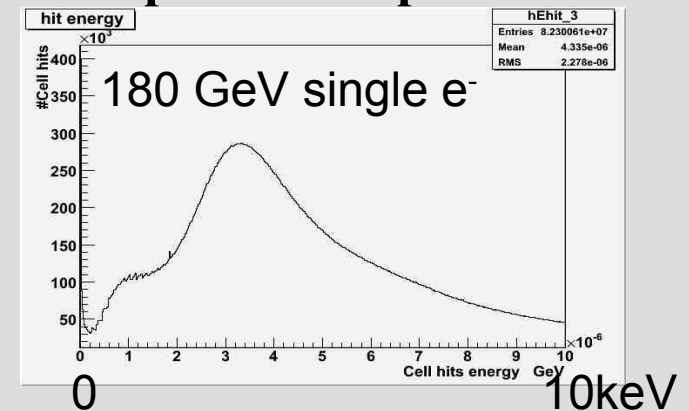
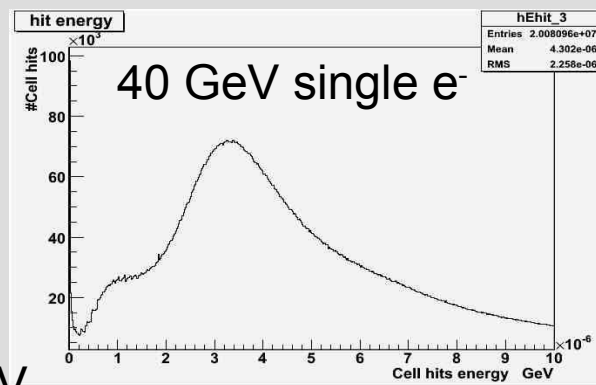
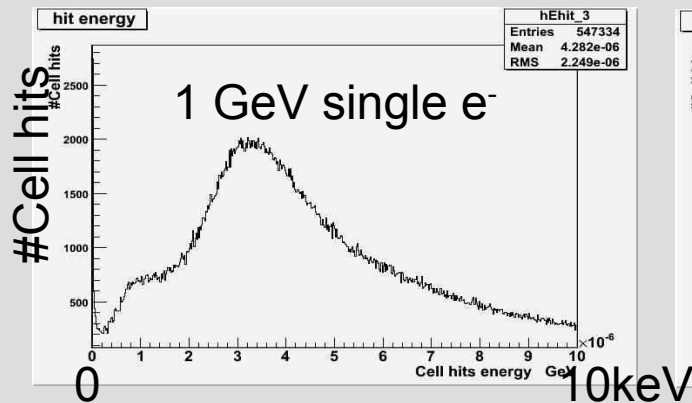


# Single $e^-$ simulation (4)

## (Incoming electron energy dependence)

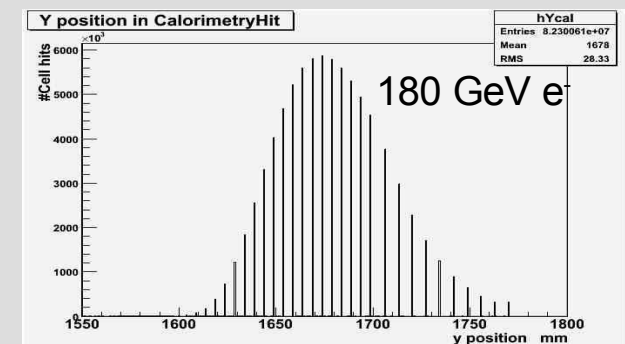
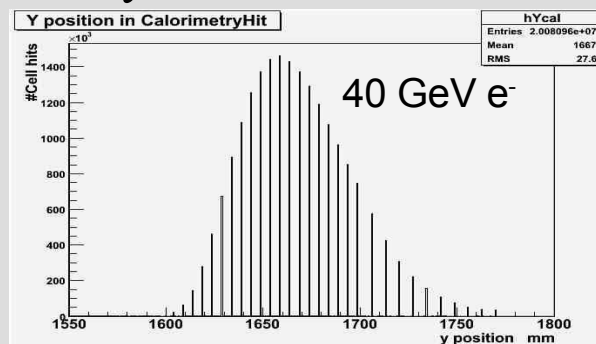
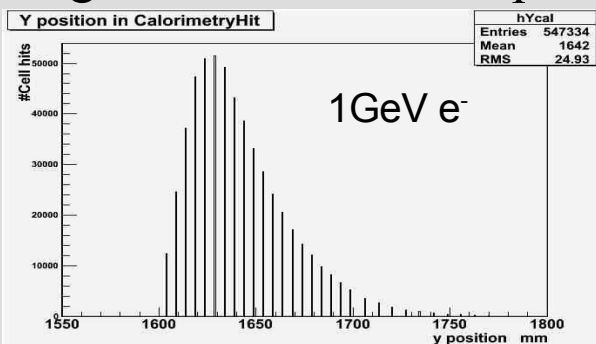
- 15 $\mu\text{m}$  Si sensitive thickness
- 50 $\mu\text{m}$  X 50 $\mu\text{m}$  cell size
- No threshold and no noise is applied.
- Before sensor level response is implemented.

Cell hit energy distributions:



Similar cell hit energy distributions except for number of cell hits.  
 -> **One MIP per cell** -> **Digital calorimetry**

Longitudinal shower shapes in 30 layers:

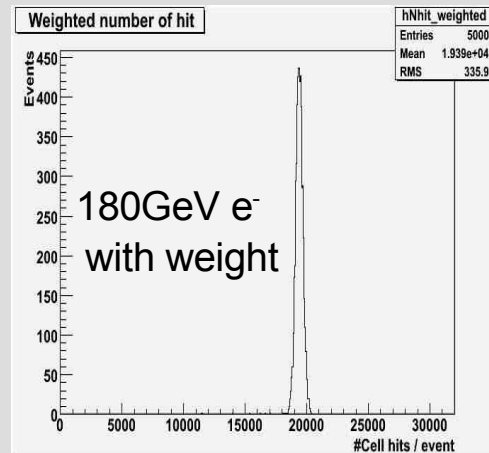
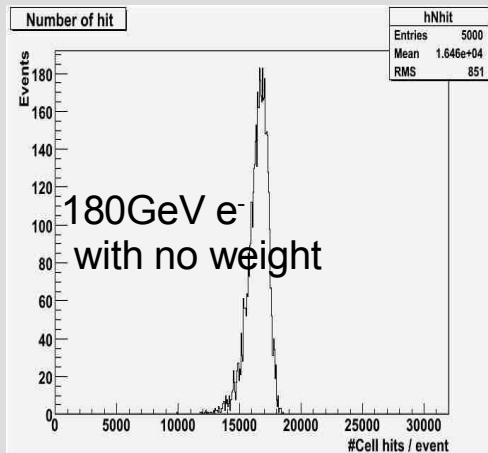


# Linearity for energy measurement

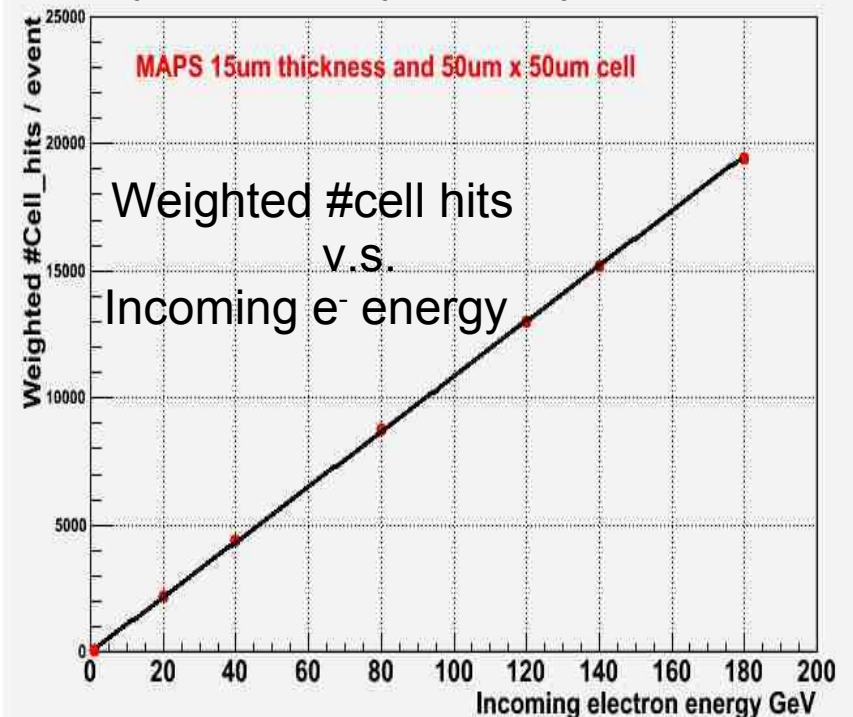
- Energy proportional to counting number of cell hits.
- 4T B field (1GeV  $e^-$  is injected just in front of ECAL, other energy  $e^-$  is from IP.)
- No threshold and no noise is applied for cell hit energy.
- Before sensor level response is implemented.
- Counting number of cell hit in a event without clustering.
- Weighted number of cell hits is used for different W thickness layers.

W thickness: 2.1mm for first 20 layers  
4.2mm for last 10 layers

$$N_{\text{weight}} = \sum_{\text{layer}\#=1}^{20} N^{\text{hit}} + 2 \sum_{\text{layer}\#=21}^{30} N^{\text{hit}}$$

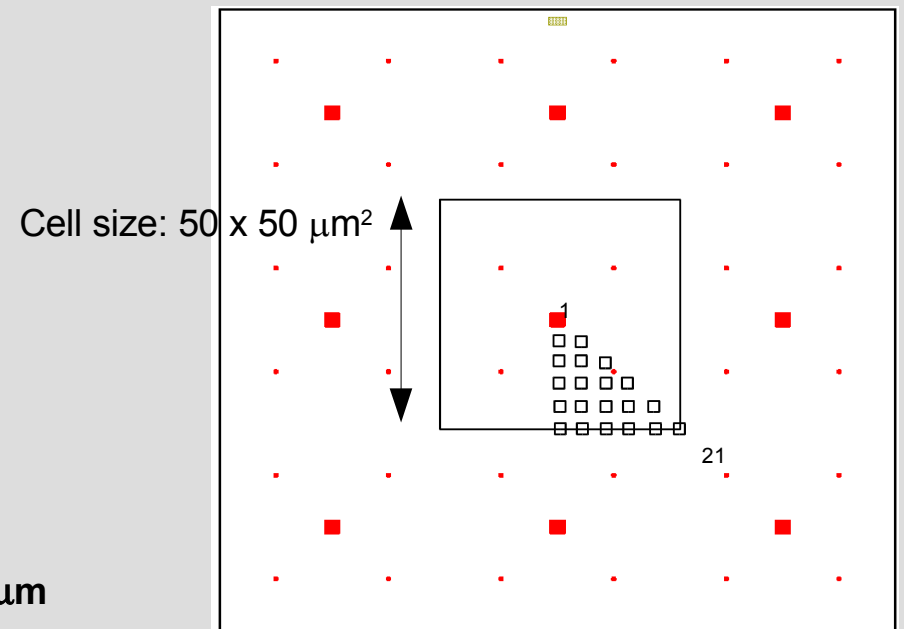
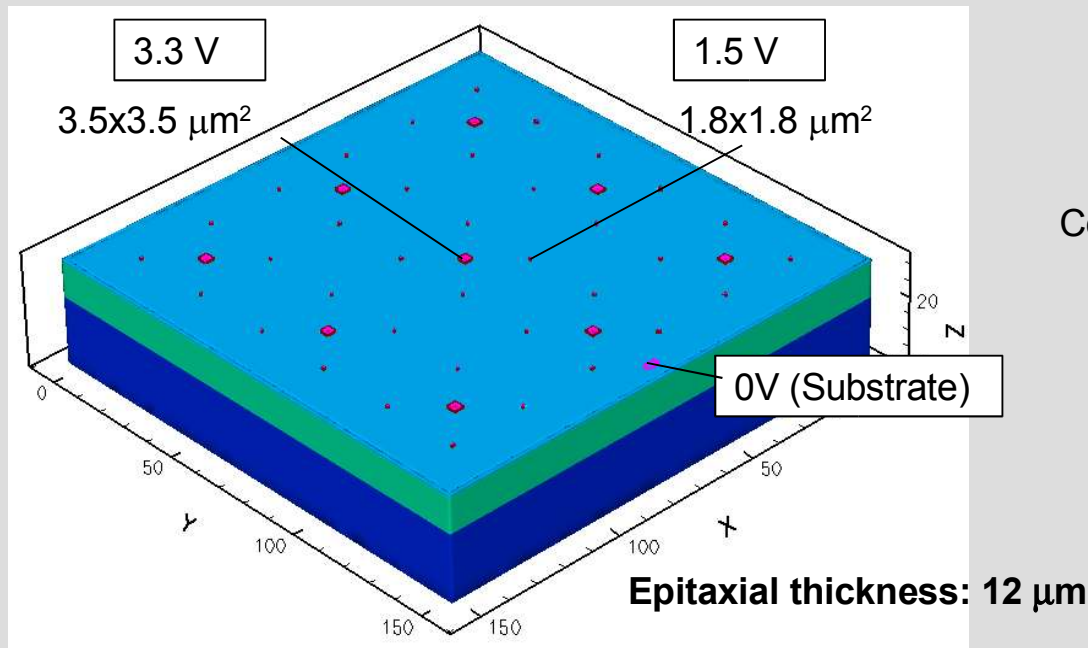


Very preliminary linearity plots:

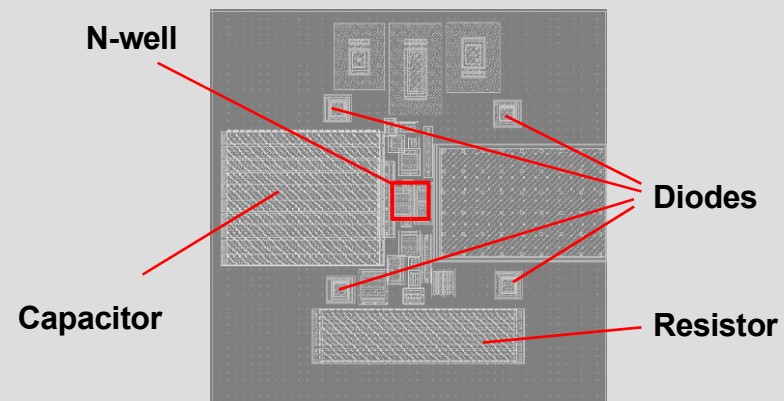


# Adding realism: Including sensor level response

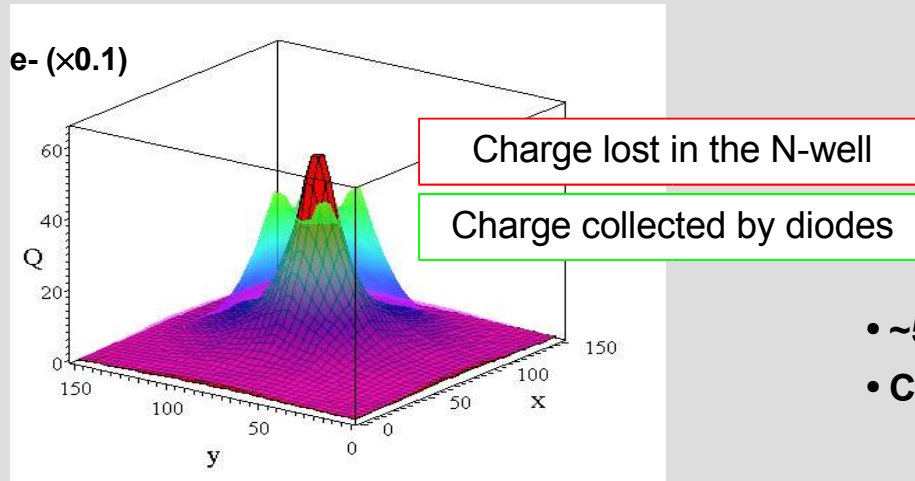
## Charge collection simulation (1)



- Full 3D device simulation
- Injected 1 MIP charge at 21 separate positions on a grid of 5  $\mu\text{m}$  pitch.
- Using the symmetry the collected charge in the rest of the device is extrapolated

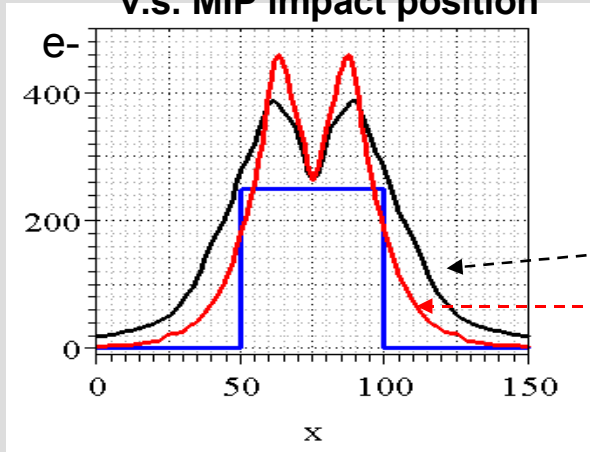


# Charge collection simulation (2)

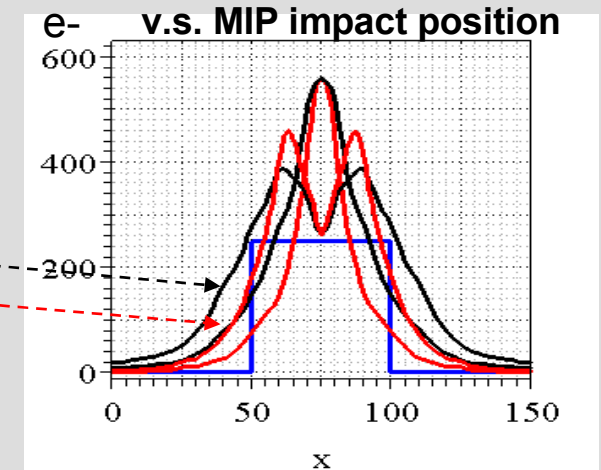


- ~50% of the charge collected when a MIP hits the N-well
- Collected charge increases with the diode size

Collected charge on the diodes  
v.s. MIP impact position

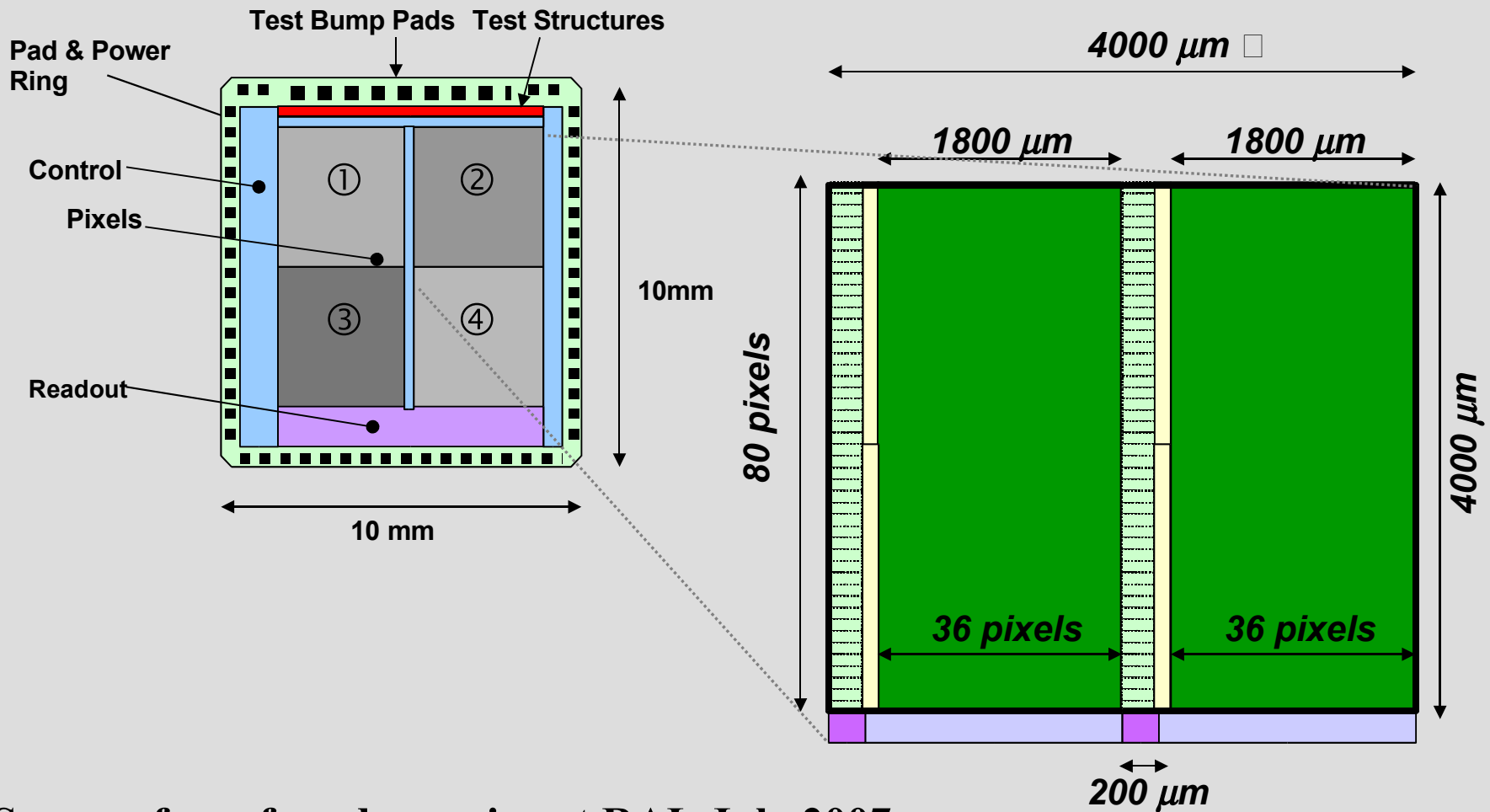


Collected charge on the diodes  
and on the N-well



# Sensor layout example

Actual test structure design



- Sensors from foundry arrive at RAL July 2007
- 200 $\mu\text{m}$  dead area in every 2mm in test structure -> will be reduced.

# Summary of status

- **MAPS geometry is implemented in full detector simulation.**
- **Each cell has only one secondary particle in most cases.**
- **50 $\mu$ m X 50 $\mu$ m cell size is reasonable starting assumption.**
- **Other ongoing studies**
  - ◆ Sensor level simulation
  - ◆ Noise and digitization
  - ◆ MAPS Electronics
  - ◆ MAPS DAQ



# Future Prospects

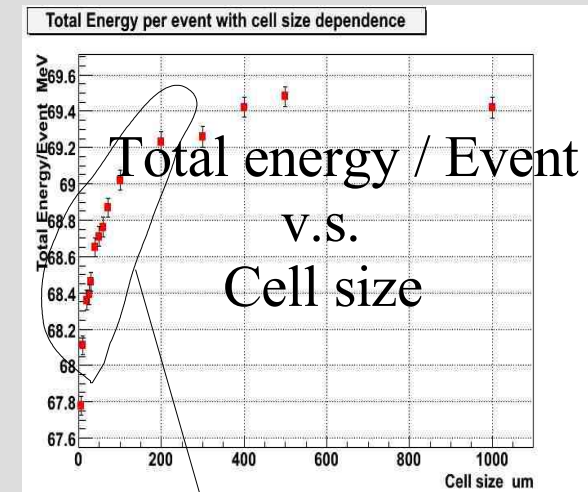
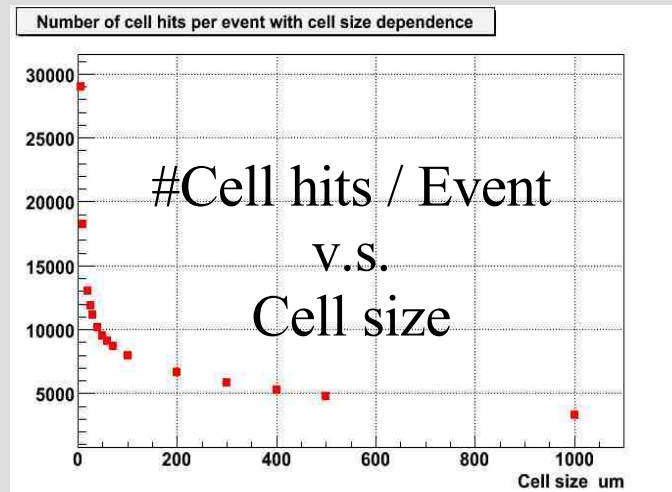
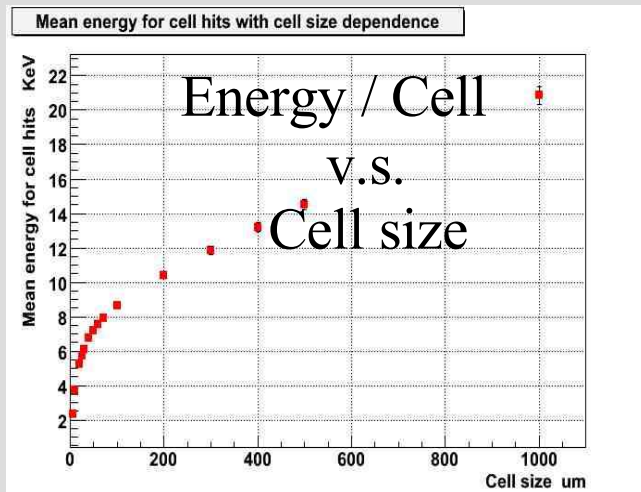
- **First sensors fabricated in August 2007**
- **Second sensor fabrication run, delivery July 2008**
- **Comparison between data and simulation**
  - MAPS geometry (After 2007 MAPS sensor is available.)
  
- **Energy resolution study with sensor response**
- **Clustering algorithm development**
- **Spatial resolution study**
- **Physics studies**

# Back up(1)

## Single $e^-$ simulation (3.b)

### (Cell size dependence)

- 100GeV  $e^-$
- 15 $\mu\text{m}$  Si sensitive
- No threshold and no noise is applied.
- Before sensor level response is implemented.



In small cell case (less than  $\sim 100 \mu\text{m} \times 100 \mu\text{m}$ ):

- Only one secondary particle pass each cell in most case.
- One MIP's energy deposit is sharing by neighbour cell.

3% bias:  
Minimum step size effect ?

